

USB Connector, Series A, DIP Type

1. INTRODUCTION

1.1. PURPOSE

Testing was performed on the TE Connectivity USB Connector, A Type, DIP Type to determine its conformance to the requirements of Product Specification 108-57874, Revision A.

1.2. SCOPE

This report covers the electrical, mechanical, and environmental performance of the TE Connectivity USB Connector.

1.3. CONCLUSION

The TE Connectivity USB Connector meets the electrical, mechanical, and environmental performance requirements of Product Specification 108-57874, Revision A.

1.4. PRODUCT DESCRIPTION

The USB Connector is designed for printed circuit board applications of PC industry.

1.5. TEST SAMPLES

Test specimens were randomly selected from normal current production lots, and the following Product were used for test :

Test Group	Quantity	Description	Part Number		
A, B, C, D, E, F, G	5 EA.	USB Connector, A Type, Receptacle Assy, DIP Type, H=6.22mm	2006737-1		

DR Eason Liu		 APVD William Kodama	DATE 24-MAY-2011
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1.6. QUALIFICATION TEST SEQUENCE

	Test Group							
Test or Examination	Α	В	С	D	Е	F	G	
	Test Sequence (a)							
Examination of Product	1, 9	1, 5	1, 8	1, 3	1, 5	1, 3	1, 3	
Contact Resistance	3, 7	2, 4			2, 4			
Dielectric withstanding Voltage			3, 7					
Insulation Resistance			2, 6					
Temperature Rising				2				
Mating Force	2							
Un-mationg Force	8							
Durability	4							
Vibration	6							
Mechanical Shock	5							
Solderability						2		
Thermal Shock			4					
Humidity			5					
Temperature Life		3						
Salt Spray					3			
Resistance to Soldering Heat							2	

NOTE: (a) Numbers indicate sequence in which tests are performed.

(b) Discontinuities shall not take place in this test group, during tests.

Figure 1



2. TEST RESUL

GP	TEST	Requirement	TEST DATA				
			Max.	Min.	Mean	Std. Dev.	Judgment
	Examination of Product	No abnormalities		PAS	SED		ACCEPTED
	Mating force.	35N Max.	13.20	10.50	11.98	1.24	ACCEPTED
	Low level contact resistance	30 mΩ Max	16.32	14.00	14.88	0.66	ACCEPTED
	Durability.	10000 cycles	PASSED			ACCEPTED	
А	Mechanical shock.	No electrical discontinuity greater than 1 µsec shall occur.	PASSED				ACCEPTED
	Vibration.	No electrical discontinuity greater than 1 µsec shall occur.	, PASSED				ACCEPTED
	Low level contact resistance	30 mΩ Max	18.73	14.28	15.43	0.93	ACCEPTED
	Unmating force.	10N Min.	8.90	6.10	7.18	1.05	ACCEPTED
	Examination of Product	No abnormalities		PAS	ACCEPTED		
	Examination of Product	No abnormalities	PASSED			ACCEPTED	
	Low level contact resistance	30 mΩ Max	16.09 13.99 14.92 0.5		0.56	ACCEPTED	
В	Temperature Life	85 ℃, 500Hrs	PASSED		ACCEPTED		
	Low level contact resistance	30 mΩ Max	15.37	13.69	14.63	0.46	ACCEPTED
	Examination of Product	No abnormalities	PASSED				ACCEPTED
	Examination of Product	No abnormalities	PASSED			ACCEPTED	
	Insulation resistance.	1,000 MΩ min.	PASSED			ACCEPTED	
	Dielectric withstanding voltage.	500 VAC, 1 Minute	PASSED			ACCEPTED	
	Thermal shock.	10 cycles , -55°C.to 85°C.	PASSED			ACCEPTED	
С	Humidity.	25℃ to 65℃, 90% to 98% RH, 168 hours	PASSED			ACCEPTED	
	Insulation resistance.	1,000 M Ω min.	PASSED			ACCEPTED	
	Dielectric withstanding voltage.	500 VAC, 1 Minute	PASSED		ACCEPTED		
	Examination of Product	No abnormalities	PASSED				ACCEPTED
	Examination of Product	No abnormalities	PASSED		ACCEPTED		
D	Temperature rise.	30℃ Max.	PASSED			ACCEPTED	
	Examination of Product	No abnormalities	PASSED			ACCEPTED	



		Requirement	DATA				
GP	TEST		Max.	Min.	Mean	Std. Dev.	Judgment
	Examination of Product	No abnormalities	PASSED			ACCEPTED	
	Low level contact resistance	30 mΩ Max	15.65	13.95	14.83	0.51	ACCEPTED
Е	Salt Spray	35°C, 5% Salt, 48hours PASSE		SED		ACCEPTED	
	Low level contact resistance	30 mΩ Max	Max 16.14 13.61 14.88 0.64		0.64	ACCEPTED	
	Examination of Product	No abnormalities	PASSED			ACCEPTED	
	Examination of Product	No abnormalities	PASSED			ACCEPTED	
F	Solderability	95% Min. coverage	PASSED		ACCEPTED		
	Examination of Product	No abnormalities	PASSED		ACCEPTED		
	Examination of Product	No abnormalities	PASSED		ACCEPTED		
G	Resistance to Soldering Heat	260+0/-5℃, 20~40sec 3 cycles	PASSED		ACCEPTED		
	Examination of Product	No abnormalities	PASSED			ACCEPTED	